April 2001



FDP7042L / FDB7042L N-Channel Logic Level PowerTrench[®] MOSFET

General Description

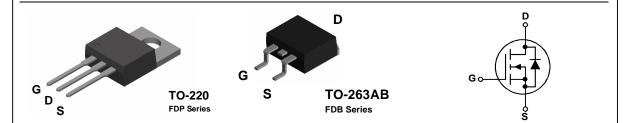
This N-Channel MOSFET has been designed specifically to improve the overall efficiency of DC/DC converters using either synchronous or conventional switching PWM controllers. It has been optimized for "low side" synchronous rectifier operation, providing an extremely low $R_{\text{DS}(\text{ON})}$.

Applications

- Synchronous rectifier
- DC/DC converter

Features

- 50 A, 30 V. $R_{DS(ON)} = 9 \ m\Omega \ @ V_{GS} = 4.5 \ V$ $R_{DS(ON)} = 7.5 \ m\Omega \ @ V_{GS} = 10 \ V$
- Critical DC electrical parameters specified at elevated temperature
- High performance trench technology for extremely low $R_{\text{DS}(\text{ON})}$
- 175°C maximum junction temperature rating



Absolute Maximum Ratings T_A=25°C unless otherwise noted

Symbol	Parameter		Ratings	Units
V _{DSS}	Drain-Source Voltage		30	V
V _{GSS}	Gate-Source Voltage		± 12	V
ID	Drain Current – Continuous	(Note 1)	50	A
	– Pulsed	(Note 1)	150	
P _D	Total Power Dissipation @ T _C = 25°C		83	W
	Derate above 25°C		0.48	W∘C
T _J , T _{STG}	Operating and Storage Junction Temperature Range		-65 to +175	°C

Thermal Characteristics

$R_{ ext{ heta}JC}$	Thermal Resistance, Junction-to-Case	1.8	°C/W
$R_{\theta JA}$	Thermal Resistance, Junction-to-Ambient	62.5	°C/W

Package Marking and Ordering Information

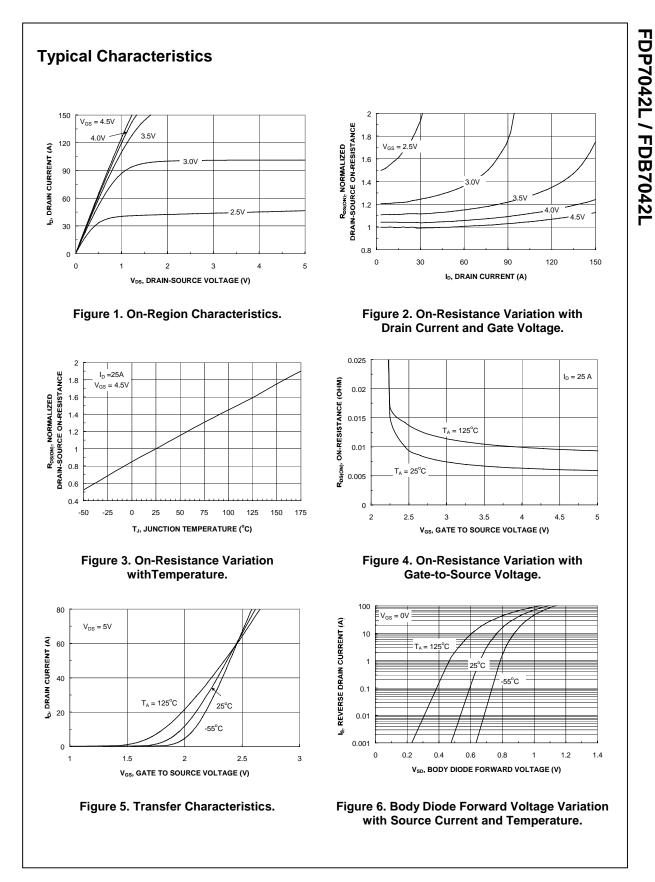
Device Marking	Device	Reel Size	Tape width	Quantity
FDB7042L	FDB7042L	13"	24mm	800 units
FDP7042L	FDP7042L	Tube	n/a	45

©2000 Fairchild Semiconductor Corporation

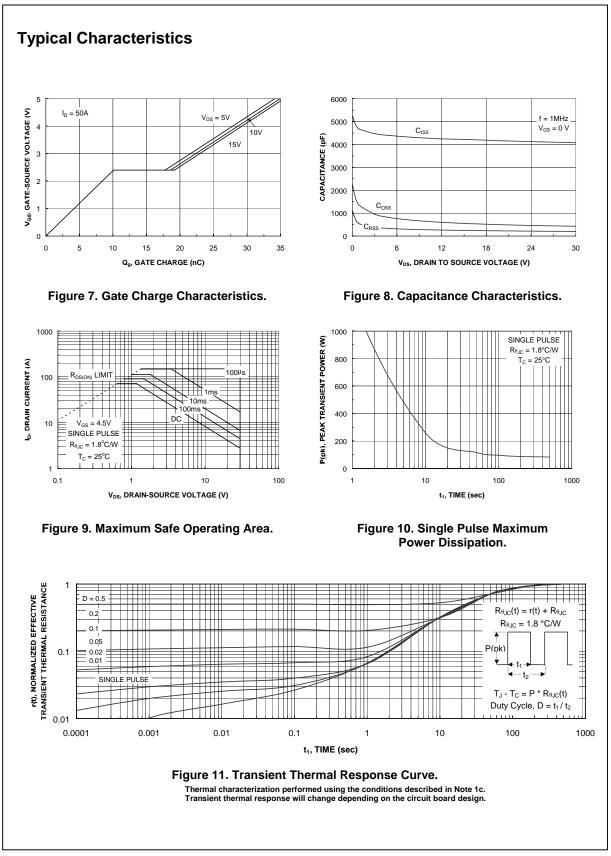
Symbol	Parameter	Test Conditions	Min	Тур	Max	Units
Off Char	acteristics	1				
BV _{DSS}	Drain–Source Breakdown Voltage	$V_{GS} = 0 V, I_D = 250 \mu A$	30			V
<u>ΔBVdss</u> ΔTj	Breakdown Voltage Temperature Coefficient	I_D = 250 µA, Referenced to 25°C		24		mV/°C
I _{DSS}	Zero Gate Voltage Drain Current	$V_{\text{DS}} = 24 \text{ V}, \qquad V_{\text{GS}} = 0 \text{ V}$			1	μA
I _{GSSF}	Gate-Body Leakage, Forward	$V_{GS} = 12 \text{ V}, \qquad V_{DS} = 0 \text{ V}$			100	nA
I _{GSSR}	Gate-Body Leakage, Reverse	$V_{GS} = -12 \text{ V} \qquad V_{DS} = 0 \text{ V}$			-100	nA
On Char	acteristics (Note 2)					
V _{GS(th)}	Gate Threshold Voltage	$V_{DS} = V_{GS}$, $I_D = 250 \ \mu A$	0.8	1.2	2	V
$\frac{\Delta V_{GS(th)}}{\Delta T_J}$	Gate Threshold Voltage Temperature Coefficient	I_D = 250 µA, Referenced to 25°C		-4.1		mV/°C
R _{DS(on)}	Static Drain–Source On–Resistance			6.2 5.5 9.6	9 7.5 16	mΩ
I _{D(on)}	On-State Drain Current	$V_{GS} = 4.5 V$, $V_{DS} = 10 V$	60			А
g _{FS}	Forward Transconductance	$V_{DS} = 5V$, $I_D = 25 A$		117		S
Dynamic	Characteristics					
Ciss	Input Capacitance			2418		pF
Coss	Output Capacitance	$V_{DS} = 15 \text{ V}, V_{GS} = 0 \text{ V},$		549		pF
C _{rss}	Reverse Transfer Capacitance	f = 1.0 MHz		243		pF
Switchir	g Characteristics (Note 2)					
t _{d(on)}	Turn–On Delay Time			21	34	ns
tr	Turn–On Rise Time	$V_{DD} = 15 V$, $I_D = 1 A$,		20	32	ns
t _{d(off)}	Turn–Off Delay Time	$V_{\text{GS}} = 4.5 \text{ V}, \ \text{R}_{\text{GEN}} = 6 \ \Omega$		60	96	ns
t _f	Turn–Off Fall Time			30	48	ns
Qg	Total Gate Charge	V 45.V 1 55.1		32	51	nC
Q _{gs}		$V_{DS} = 15 \text{ V}, I_D = 50 \text{ A}, V_{GS} = 4.5 \text{ V}$		10		nC
Q _{gd}	Gate–Drain Charge			9		nC
Drain-S	ource Diode Characteristics a	Ind Maximum Ratings				
ls	Maximum Continuous Drain-Source				50	А
V _{SD}	Drain–Source Diode Forward Voltage	$V_{GS} = 0 V$, $I_S = 25 A$ (Note 2)		0.8	1.3	V

1. Maximum continuous current is limited by the package.

2. Pulse Test: Pulse Width < 300 μ s, Duty Cycle < 2.0%



FDP7042L Rev C(W)



FDP7042L / FDB7042L

FDP7042L Rev C(W)

TRADEMARKS The following are registered and unregistered trademarks Fairchild Semiconductor owns or is authorized to use and is not intended to be an exhaustive list of all such trademarks. FAST[®] ACEx™ PACMAN™ SuperSOT[™]-3 FASTr™ POP™ SuperSOT[™]-6 Bottomless™ GlobalOptoisolator™ CoolFET™ PowerTrench ® SuperSOT[™]-8 CROSSVOLT™ GTO™ QFET™ SyncFET™ TinyLogic™ DenseTrench™ HiSeC™ QS™ UHC™ DOME™ ISOPLANAR™ QT Optoelectronics[™] EcoSPARK™ LittleFET™ Quiet Series[™] UltraFET[®] SILENT SWITCHER ® VCX™ E²CMOS[™] MicroFET™ EnSigna™ SMART START™ MICROWIRE™ FACT™ OPTOLOGIC™ Star* Power™ **OPTOPLANAR™** Stealth™ FACT Quiet Series™

DISCLAIMER

FAIRCHILD SEMICONDUCTOR RESERVES THE RIGHT TO MAKE CHANGES WITHOUT FURTHER NOTICE TO ANY PRODUCTS HEREIN TO IMPROVE RELIABILITY, FUNCTION OR DESIGN. FAIRCHILD DOES NOT ASSUME ANY LIABILITY ARISING OUT OF THE APPLICATION OR USE OF ANY PRODUCT OR CIRCUIT DESCRIBED HEREIN; NEITHER DOES IT CONVEY ANY LICENSE UNDER ITS PATENT RIGHTS, NOR THE RIGHTS OF OTHERS.

LIFE SUPPORT POLICY

FAIRCHILD'S PRODUCTS ARE NOT AUTHORIZED FOR USE AS CRITICAL COMPONENTS IN LIFE SUPPORT DEVICES OR SYSTEMS WITHOUT THE EXPRESS WRITTEN APPROVAL OF FAIRCHILD SEMICONDUCTOR CORPORATION. As used herein:

1. Life support devices or systems are devices or systems which, (a) are intended for surgical implant into the body, or (b) support or sustain life, or (c) whose failure to perform when properly used in accordance with instructions for use provided in the labeling, can be reasonably expected to result in significant injury to the user. 2. A critical component is any component of a life support device or system whose failure to perform can be reasonably expected to cause the failure of the life support device or system, or to affect its safety or effectiveness.

PRODUCT STATUS DEFINITIONS

Definition of Terms

Datasheet Identification	Product Status	Definition
Advance Information	Formative or In Design	This datasheet contains the design specifications for product development. Specifications may change in any manner without notice.
Preliminary	First Production	This datasheet contains preliminary data, and supplementary data will be published at a later date. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
No Identification Needed	Full Production	This datasheet contains final specifications. Fairchild Semiconductor reserves the right to make changes at any time without notice in order to improve design.
Obsolete	Not In Production	This datasheet contains specifications on a product that has been discontinued by Fairchild semiconductor. The datasheet is printed for reference information only.
	•	• Rev. H1